## 1 Product profile

### 1.1 General description

Quad PIN diode in a SOT753 package.

#### 1.2 Features and benefits

- 4 PIN diodes in a SOT753 package
- 300 kHz to 4 GHz
- High linearity
- · Low insertion loss
- reduction in part count
- · Low diode capacitance
- · Low diode forward resistance

#### 1.3 Applications

- RF attenuators
- Broadband system applications
- General-purpose Voltage Controlled Attenuators for high linearity applications



Quad PIN diode attenuator

## 2 Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	RF in	D- D.	
2	series bias	<u> </u>	5 4
3	RF out		
4	shunt 1 bias	1 1 2 3	1 2 3
5	shunt 2 bias	Top view	sym143

## 3 Ordering information

**Table 2. Ordering information** 

- table = 1 or table mg morning morning management					
Type number	Package	Package			
	Name	Description	Version		
BAP64Q	SC-74A	plastic surface-mounted package; 5 leads	SOT753		

## 4 Marking

Table 3. Marking

Type number	Marking code
BAP64Q	A1

## 5 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage		[1]	-	100	V
I <sub>F</sub>	forward current		[1]	-	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> ≤ 90 °C	[1]	-	125	mW
T <sub>stg</sub>	storage temperature			-65	+150	°C
Tj	junction temperature			-65	+150	°C

<sup>[1]</sup> single diode.

#### 6 Thermal characteristics

**Table 5. Thermal characteristics** 

Table of Thomas officerous				
Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		350	K/W

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**Quad PIN diode attenuator** 

### 7 Characteristics

**Table 6. Characteristics** 

 $T_i$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diod	e		<b>,</b>			-	
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA		-	0.95	1.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 60 V		-	-	10	μΑ
		V <sub>R</sub> = 20 V		-	-	1	μΑ
C <sub>d</sub>	diode capacitance	f = 1 MHz (see Figure 1)					-
		V <sub>R</sub> = 0 V		-	0.52	-	pF
		V <sub>R</sub> = 1 V		-	0.37	-	pF
		V <sub>R</sub> = 20 V		-	0.23	0.35	pF
r <sub>D</sub>	diode forward resistance	f = 100 MHz (see Figure 2)					
		I <sub>F</sub> = 0.5 mA	[1]	-	20	40	Ω
		I <sub>F</sub> = 1 mA	[1]	-	10	20	Ω
		I <sub>F</sub> = 10 mA	[1]	-	2	3.8	Ω
		I <sub>F</sub> = 100 mA	[1]	-	0.7	1.35	Ω
τι	charge carrier life time	when switched from $I_F$ = 10 mA to $I_R$ = 6 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 3 mA		-	1.55	-	μs

<sup>[1]</sup> Guaranteed on AQL basis: inspection level S4, AQL 1.0.

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#### **Quad PIN diode attenuator**

## **Graphical data**

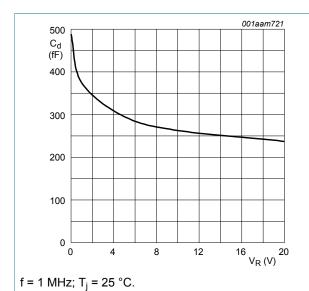
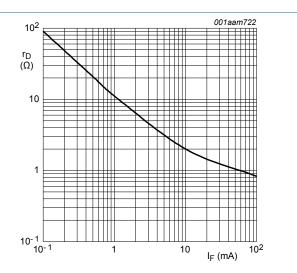


Figure 1. Diode capacitance as a function of reverse voltage (typical values)



f = 100 MHz;  $T_j = 25 \,^{\circ}\text{C}$ .

Figure 2. Diode forward resistance as a function of forward current (typical values)

**Quad PIN diode attenuator** 

## 9 Application information

### 9.1 Application circuit

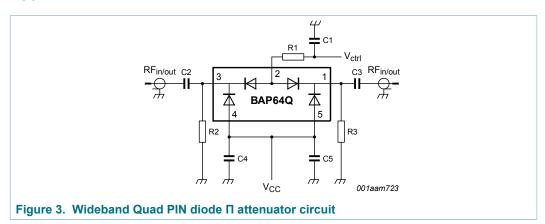


Table 7. List of components used for the typical application

Component	Description	Value
C1; C2; C3; C4; C5	chip capacitor	10 nF
R1; R2; R3	chip resistor	1000 Ω

#### 9.2 Quad PIN Π attenuator characteristics

Table 8. Typical performance for BAP64Q quad PIN diode  $\Pi$  attenuator

 $V_{CC}$  = 0.75 V;  $T_{amb}$  = 25 °C unless otherwise specified.

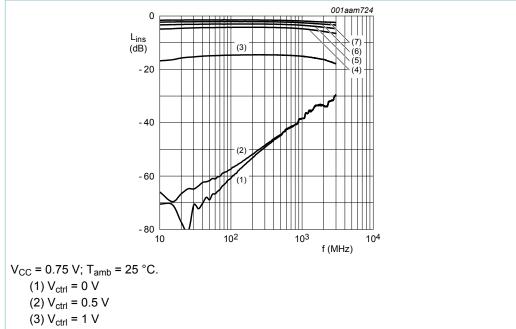
Symbol	Parameter	Test Conditions	Тур	Units	
L <sub>ins</sub>	insertion loss	V <sub>ctrl</sub> = 10 V; f = 1 GHz	1.8	dB	
RLin	input return loss	V <sub>ctrl</sub> = 0 V; f = 1 GHz	18	dB	
α	attenuation	V <sub>ctrl</sub> = 0 V; f = 1 GHz	38	dB	
IP3 <sub>i</sub>	input third-order intercept point	f = 0.1 GHz			
		V <sub>ctrl</sub> = 2 V	32	dBm	
		V <sub>ctrl</sub> = 10 V	42	dBm	
		f = 0.9 GHz			
		V <sub>ctrl</sub> = 2 V	40	dBm	
		V <sub>ctrl</sub> = 10 V	41	dBm	
		f = 1.8 GHz			
		V <sub>ctrl</sub> = 2 V	40	dBm	
		V <sub>ctrl</sub> = 10 V	37	dBm	
		f = 2.1 GHz			
		V <sub>ctrl</sub> = 2 V	38	dBm	
		V <sub>ctrl</sub> = 10 V	39	dBm	

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#### **Quad PIN diode attenuator**



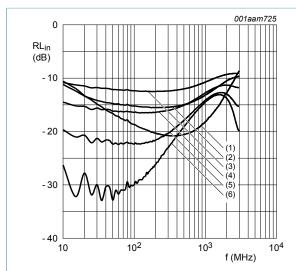
(4)  $V_{ctrl} = 2 V$ 

(5)  $V_{ctrl} = 3 V$ 

(6)  $V_{ctrl} = 5 V$ 

 $(7) V_{ctrl} = 10 V$ 

Figure 4. Insertion loss as function of frequency (typical values)



 $V_{CC}$  = 0.75 V;  $T_{amb}$  = 25 °C.

(1) 
$$V_{ctrl} = 0 V$$

(2) 
$$V_{ctrl} = 1 V$$

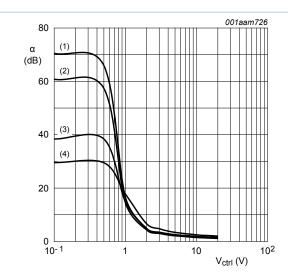
(3) 
$$V_{ctrl} = 2 V$$

(4) 
$$V_{ctrl} = 3 V$$

(5) 
$$V_{ctrl} = 5 V$$

(6) 
$$V_{ctrl} = 10 \text{ V}$$





 $V_{CC}$  = 0.75 V;  $T_{amb}$  = 25 °C.

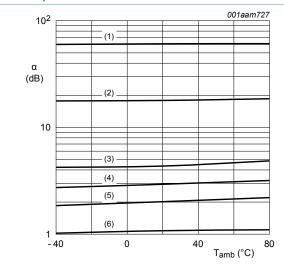
$$(1) f = 10 MHz$$

$$(2) f = 100 MHz$$

$$(3) f = 1000 MHz$$

$$(4) f = 3000 MHz$$

#### Figure 6. Attenuation as function of control voltage (typical values)



 $V_{CC} = 0.75 \text{ V}$ ; f = 100 MHz.

(1) 
$$V_{ctrl} = 0 V$$

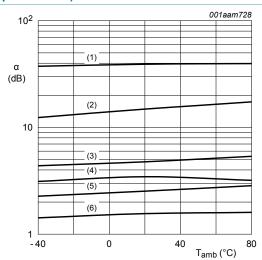
(2) 
$$V_{ctrl} = 1 V$$

(3) 
$$V_{ctrl} = 2 V$$

$$(4) V_{ctrl} = 3 V$$

$$(5) V_{ctrl} = 5 V$$

values)



 $V_{CC} = 0.75 \text{ V}$ ; f = 1000 MHz.

(1) 
$$V_{ctrl} = 0 V$$

(2) 
$$V_{ctrl} = 1 V$$

(3) 
$$V_{ctrl} = 2 V$$

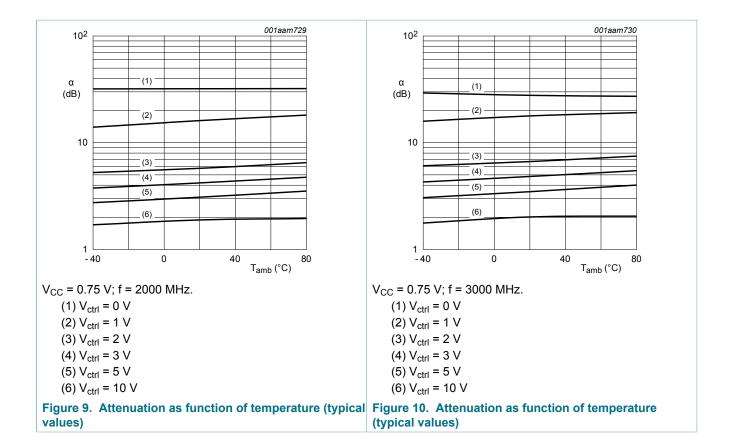
(4) 
$$V_{ctrl} = 3 V$$

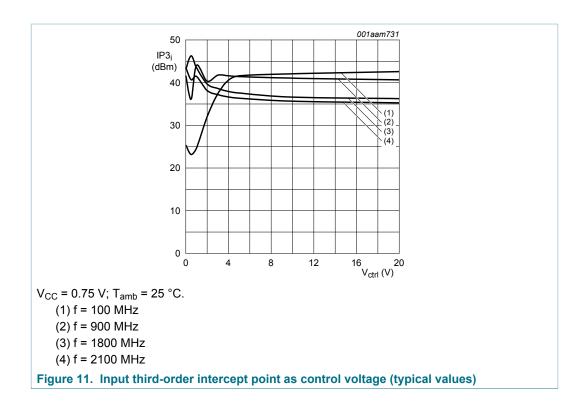
(5) 
$$V_{ctrl} = 5 V$$

(6) 
$$V_{ctrl} = 10 \text{ V}$$

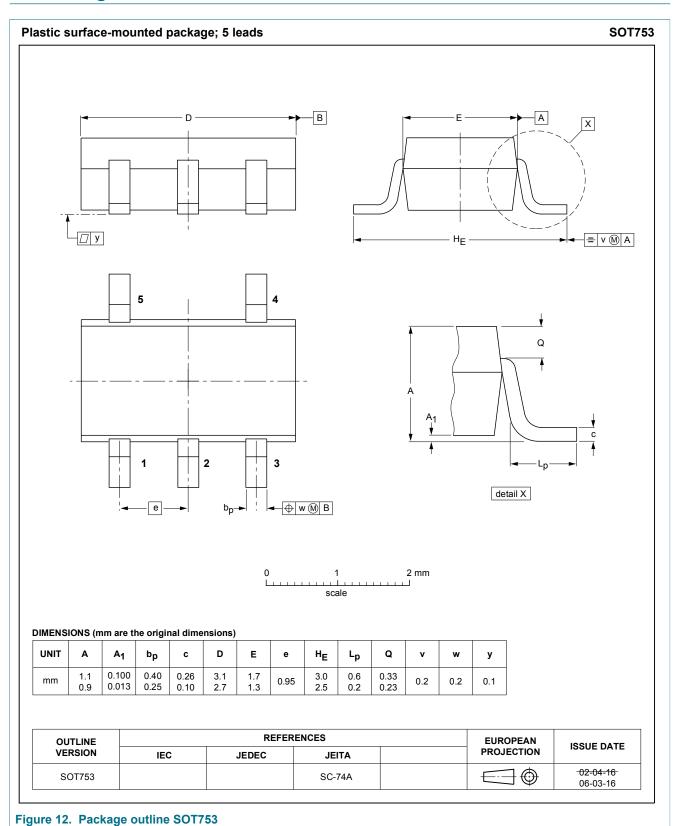
Figure 7. Attenuation as function of temperature (typical Figure 8. Attenuation as function of temperature (typical values)

#### **Quad PIN diode attenuator**





## 10 Package outline



**Quad PIN diode attenuator** 

### 11 Abbreviations

Table 9. Abbreviations

Acronym	Description
AQL	acceptable quality level
PIN	P-type, intrinsic, N-type
RF	radio frequency
S4	special inspection level 4

## 12 Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BAP64Q v.2.1	20190201	Product data sheet	-	BAP64Q v.2		
Modifications:	<ul> <li>changed condition</li> </ul>	on for reverse current for V <sub>R</sub> f	rom 100 V to 60 V			
BAP64Q v.2	20181213	Product data sheet	-	BAP64Q v.1		
Modifications:	_	<ul> <li>The "Legal information" pages have been updated.</li> <li>Adjusted Limiting Value P<sub>tot</sub> to T<sub>sp</sub> ≤ 90 °C</li> </ul>				
BAP64Q v.1	20101007	Product data sheet	-	-		

**Quad PIN diode attenuator** 

### 13 Legal information

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# BAP64Q

### Quad PIN diode attenuator

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